



Chipsmall Limited consists of a professional team with an average of over 10 year of expertise in the distribution of electronic components. Based in Hongkong, we have already established firm and mutual-benefit business relationships with customers from,Europe,America and south Asia,supplying obsolete and hard-to-find components to meet their specific needs.

With the principle of “Quality Parts,Customers Priority,Honest Operation,and Considerate Service”,our business mainly focus on the distribution of electronic components. Line cards we deal with include Microchip,ALPS,ROHM,Xilinx,Pulse,ON,Everlight and Freescale. Main products comprise IC,Modules,Potentiometer,IC Socket,Relay,Connector.Our parts cover such applications as commercial,industrial, and automotives areas.

We are looking forward to setting up business relationship with you and hope to provide you with the best service and solution. Let us make a better world for our industry!



## Contact us

Tel: +86-755-8981 8866 Fax: +86-755-8427 6832

Email & Skype: info@chipsmall.com Web: www.chipsmall.com

Address: A1208, Overseas Decoration Building, #122 Zhenhua RD., Futian, Shenzhen, China





# STMPS2242, STMPS2252 STMPS2262, STMPS2272

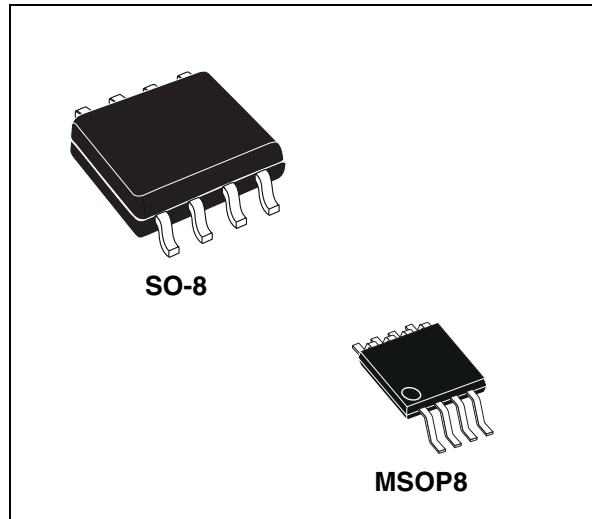
## Enhanced dual-channel power switches

### Features

- 100 mΩ high-side MOSFET switch
- 500 mA/1000 mA continuous current per channel
- Thermal protection
- Independent short-circuit protection with overcurrent logic output
- Operating range from 2.7 V to 5.5 V
- CMOS and TTL compatible inputs
- 2.5 ms typical rise time
- Undervoltage lockout
- 13 μA maximum standby supply current
- Ambient temperature range: -40 °C to 85 °C
- 8 kV ESD protection
- Reverse current protection
- Fault blanking

### Description

The STMPS2242/2252/2262/2272 power distribution switches are intended for applications where heavy capacitive loads and short-circuits are likely to be encountered. These devices incorporate 100 mΩ MOSFET high-side power switches for power distribution systems that require multiple power switches in a single package.



Each switch is controlled by an independent logic enable input. When the output load exceeds the current limit threshold or a short is present, these devices limit the output current to a safe level by switching into a constant current mode, pulling the overcurrent (OCx) logic output low. When continuous heavy overloads and short-circuits increase the power dissipation in the switch, causing the junction temperature to rise, a thermal protection circuit shuts off the switch to prevent damage. Recovery from a thermal shutdown is automatic once the device has cooled sufficiently. Internal circuitry ensures the switch remains off until valid input voltage is present.

Table 1. Device summary

Order code		Current limit (mA)	Enable	Packing
SO-8	MSOP8 <sup>(1)</sup>			
STMPS2242MTR	STMPS2242TTR	500	Active low	Tape and reel
STMPS2252MTR	STMPS2252TTR	500	Active high	Tape and reel
STMPS2262MTR	STMPS2262TTR	1000	Active low	Tape and reel
STMPS2272MTR	STMPS2272TTR	1000	Active high	Tape and reel

1. MSOP8 is also known as TSSOP8.

# Contents

<b>1</b>	<b>Block diagram</b>	<b>6</b>
<b>2</b>	<b>Pin descriptions</b>	<b>7</b>
<b>3</b>	<b>Functional description</b>	<b>8</b>
3.1	Fault blanking	8
3.2	Overcurrent/overtemperature protection	8
3.3	Reverse current blocking	8
3.4	UVLO	8
<b>4</b>	<b>Maximum rating</b>	<b>9</b>
4.1	Absolute maximum rating	9
4.2	Recommended operating conditions	9
<b>5</b>	<b>Electrical specifications</b>	<b>10</b>
<b>6</b>	<b>Typical operating characteristics</b>	<b>13</b>
6.1	STMPS2242, STMPS2252 characteristics	13
6.1.1	Turn-on/off characteristics for $V_I = 3\text{ V}$ , $R_{LOAD} = 6\ \Omega$	13
6.1.2	Turn-on/off characteristics for $V_I = 5\text{ V}$ , $R_{LOAD} = 10\ \Omega$	16
6.1.3	UVLO characteristics	20
6.1.4	Overcurrent protection characteristics	21
6.1.5	Other electrical characteristics	22
6.2	STMPS2262, STMPS2272 characteristics	24
6.2.1	Turn-on/off characteristics for $V_I = 3\text{ V}$ , $R_{LOAD} = 3\ \Omega$	24
6.2.2	Turn-on/off characteristics for $V_I = 5\text{ V}$ , $R_{LOAD} = 5\ \Omega$	27
6.2.3	UVLO characteristics	30
6.2.4	Overcurrent protection characteristics	32
6.2.5	Other electrical characteristics	33
<b>7</b>	<b>Application information</b>	<b>35</b>
7.1	Input and output capacitors	35
<b>8</b>	<b>Package mechanical data</b>	<b>36</b>

**9**      **Revision history** ..... **41**

## List of tables

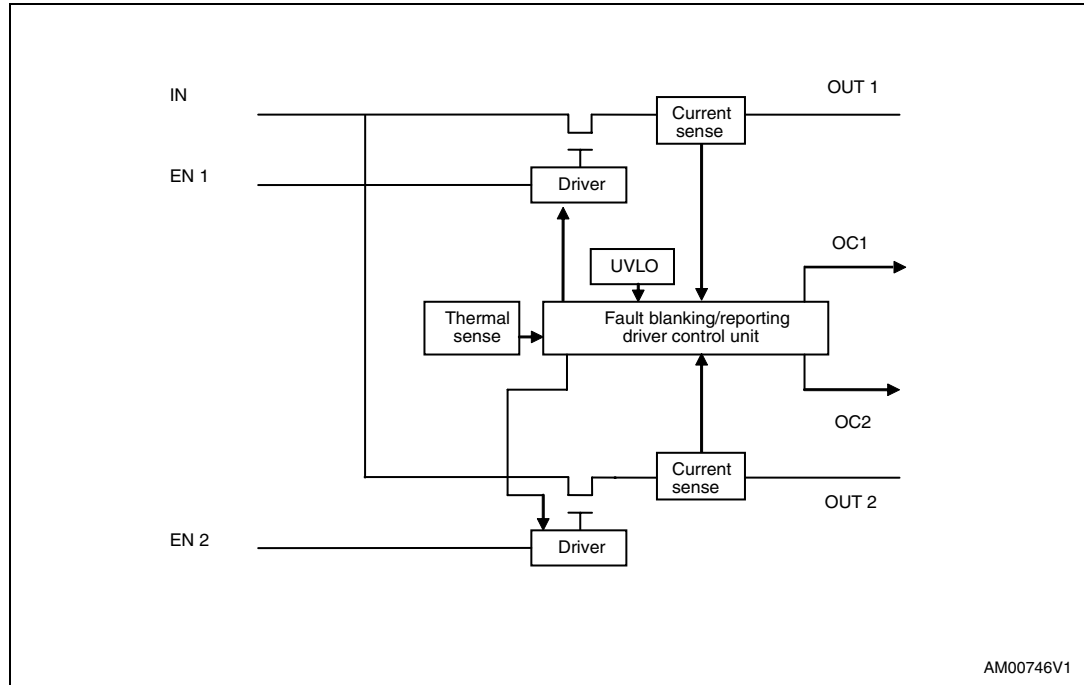
Table 1.	Device summary . . . . .	1
Table 2.	Pin descriptions . . . . .	7
Table 3.	Absolute maximum ratings . . . . .	9
Table 4.	Recommended operating conditions . . . . .	9
Table 5.	Electrical characteristics . . . . .	10
Table 6.	Current limit characteristics ( $V_I = 5.5\text{ V}$ , $I_O = \text{rated current}$ , $T_J = 25^\circ\text{C}$ , unless otherwise specified) . . . . .	10
Table 7.	Supply current characteristics ( $V_I = 5.5\text{ V}$ , $I_O = \text{rated current}$ , $T_J = 25^\circ\text{C}$ , unless otherwise specified) . . . . .	11
Table 8.	Thermal characteristics ( $V_I = 5.5\text{ V}$ , $I_O = \text{rated current}$ , $T_J = 25^\circ\text{C}$ , unless otherwise specified) . . . . .	11
Table 9.	UVLO characteristics ( $V_I = 5.5\text{ V}$ , $I_O = \text{rated current}$ , $T_J = 25^\circ\text{C}$ , unless otherwise specified) . . . . .	12
Table 10.	OCx pin characteristics ( $V_I = 5.5\text{ V}$ , $I_O = \text{rated current}$ , $T_J = 25^\circ\text{C}$ , unless otherwise specified) . . . . .	12
Table 11.	ENx pin characteristics ( $V_I = 5.5\text{ V}$ , $I_O = \text{rated current}$ , $T_J = 25^\circ\text{C}$ , unless otherwise specified) . . . . .	12
Table 12.	SO-8 mechanical data . . . . .	37
Table 13.	MSOP8 mechanical data . . . . .	38
Table 14.	Reel mechanical data . . . . .	40
Table 15.	Document revision history . . . . .	41

## List of figures

Figure 1.	Block diagram	6
Figure 2.	Pinout	7
Figure 3.	Turn-on for $C_{LOAD} = 1 \mu F$	13
Figure 4.	Turn-on for $C_{LOAD} = 100 \mu F$	14
Figure 5.	Turn-on for $C_{LOAD} = 470 \mu F$	14
Figure 6.	Turn-off for $C_{LOAD} = 1 \mu F$	15
Figure 7.	Turn-off for $C_{LOAD} = 100 \mu F$	15
Figure 8.	Turn-off for $C_{LOAD} = 470 \mu F$	16
Figure 9.	Turn-on for $C_{LOAD} = 1 \mu F$	16
Figure 10.	Turn-on for $C_{LOAD} = 100 \mu F$	17
Figure 11.	Turn-on for $C_{LOAD} = 470 \mu F$	17
Figure 12.	Turn-off for $C_{LOAD} = 1 \mu F$	18
Figure 13.	Turn-off for $C_{LOAD} = 100 \mu F$	18
Figure 14.	Turn-off for $C_{LOAD} = 470 \mu F$	19
Figure 15.	UVLO, $V_I$ rising	20
Figure 16.	UVLO, $V_I$ falling	20
Figure 17.	Overcurrent protection characteristics, $V_I = 3 V$ , $R_{LOAD} = 2.2 \Omega$	21
Figure 18.	Overcurrent protection characteristics, $V_I = 5 V$ , $R_{LOAD} = 2.2 \Omega$	21
Figure 19.	$I_{CC}$ versus $V_I$	22
Figure 20.	$t_r$ versus $V_I$	22
Figure 21.	$t_f$ versus $V_I$	23
Figure 22.	$R_{ds(on)}$ versus $V_I$	23
Figure 23.	Turn-on for $C_{LOAD} = 1 \mu F$	24
Figure 24.	Turn-on for $C_{LOAD} = 100 \mu F$	25
Figure 25.	Turn-on for $C_{LOAD} = 470 \mu F$	25
Figure 26.	Turn-off for $C_{LOAD} = 1 \mu F$	26
Figure 27.	Turn-off for $C_{LOAD} = 100 \mu F$	26
Figure 28.	Turn-off for $C_{LOAD} = 470 \mu F$	27
Figure 29.	Turn-on for $C_{LOAD} = 1 \mu F$	27
Figure 30.	Turn-on for $C_{LOAD} = 100 \mu F$	28
Figure 31.	Turn-on for $C_{LOAD} = 470 \mu F$	28
Figure 32.	Turn-off for $C_{LOAD} = 1 \mu F$	29
Figure 33.	Turn-off for $C_{LOAD} = 100 \mu F$	29
Figure 34.	Turn-off for $C_{LOAD} = 470 \mu F$	30
Figure 35.	UVLO, $V_I$ rising	30
Figure 36.	UVLO, $V_I$ falling	31
Figure 37.	Overcurrent protection characteristics, $V_I = 3 V$ , $R_{LOAD} = 1 \Omega$	32
Figure 38.	Overcurrent protection characteristics, $V_I = 5 V$ , $R_{LOAD} = 1 \Omega$	32
Figure 39.	$I_{CC}$ versus $V_I$	33
Figure 40.	$t_r$ versus $V_I$	33
Figure 41.	$t_f$ versus $V_I$	34
Figure 42.	$R_{ds(on)}$ versus $V_I$	34
Figure 43.	SO-8 package outline	36
Figure 44.	MSOP8 package outline	38
Figure 45.	SO-8 carrier tape	39
Figure 46.	MSOP8 carrier tape	39
Figure 47.	Reel information	40

# 1 Block diagram

Figure 1. Block diagram



## 2 Pin descriptions

Figure 2. Pinout

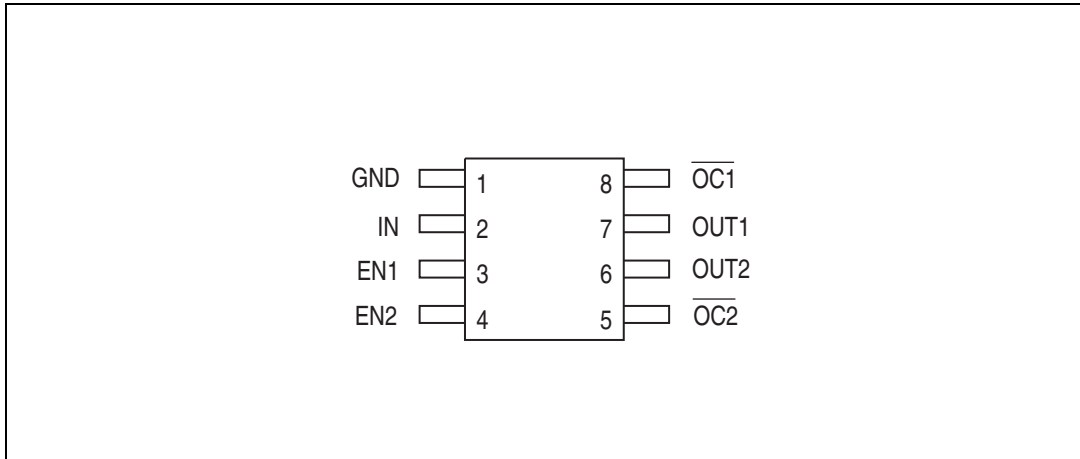


Table 2. Pin descriptions

Pin number	Name	Type	Function
1	GND	—	Ground
2	IN	—	V <sub>CC</sub> input, 2.7 - 5.5 V
3	$\overline{EN1}/EN1$	I	Channel 1 active low (STMPS2242 and STMPS2262) or active high (STMPS2252 and STMPS2272) enable
4	$\overline{EN2}/EN2$	I	Channel 2 active low (STMPS2242 and STMPS2262) or active high (STMPS2252 and STMPS2272) enable
5	$\overline{OC2}$	O	Open drain output for fault indication of channel 2
6	OUT2	—	Output of channel 2
7	OUT1	—	Output of channel 1
8	$\overline{OC1}$	O	Open drain output for fault indication of channel 1



## 3 Functional description

### 3.1 Fault blanking

The STMPS devices feature a 10 ms fault blanking. Fault blanking allows current-limit faults, including momentary short-circuit faults that occur when hot-swapping a capacitive load, and also ensures that no fault is issued during power-up. When a load transient causes the device to enter current limit, an internal counter starts. If the load fault persists beyond the 10 ms fault-blanking timeout, the FAULT output asserts “low”. Load-transient faults less than 10 ms (typ.) do not cause a FAULT output assertion. Only current-limit faults have fault-blanking. Die overtemperature faults and input voltage drops below the UVLO threshold cause an immediate fault output.

### 3.2 Overcurrent/overtemperature protection

In overcurrent or short-circuit condition, the switch limits the current at 500 mA for STMPS2242/STMPS2252 and 1000 mA for STMPS2262/STMPS2272. If the temperature of the die goes above the limit value, the switch turns OFF.

### 3.3 Reverse current blocking

When the switch is OFF, or when the STMPS device is not powered ( $V_{CC}=0$  V), the switch behaves as a Hi-Z at the output pin, ensuring that no reverse current will flow into the device when  $V_I < V_O$ .

*Note:* In the case where the switch is ON, and a voltage higher than  $V_I$  is applied to the OUT pin, a reverse current will occur.

### 3.4 UVLO

When the input voltage drops below the threshold value, the power switch turns OFF to prevent improper operation due to low voltage.

## 4 Maximum rating

Stressing the device above the rating listed in the absolute maximum ratings table may cause permanent damage to the device. These are stress ratings only and operation of the device at these or any other conditions above those indicated in the operating sections of this specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

### 4.1 Absolute maximum rating

**Table 3. Absolute maximum ratings**

Symbol	Parameter	Value	Unit
$V_I$	Input voltage range	-0.3 – 6.0	V
$V_O$	Output voltage range	-0.3 – ( $V_I + 0.3$ )	V
$V_{IENx}$	EN input voltage range	-0.3 – 6.0	V
$I_O$	Continuous output current	Internally limited	
ESD	ESD protection level	8	kV
$T_J$	Junction operating temperature	-40 to 125	°C
$T_{STG}$	Storage temperature	-55 to 150	°C
$T_R$	Thermal resistance (MSOP8)	220	°C/W
$T_R$	Thermal resistance (SO-8)	160	°C/W

### 4.2 Recommended operating conditions

**Table 4. Recommended operating conditions**

Symbol	Parameter	Value			Unit
		Min	Typ	Max	
$V_I$	Input voltage	2.7	5.0	5.5	V
$V_O$	Output voltage	0	5.0	5.5	V
$I_O$ (STMPS2242 STMPS2252)	Continuous output current	0	-	500	mA
$I_O$ (STMPS2262 STMPS2272)	Continuous output current	0	-	1000	mA

## 5 Electrical specifications

**Table 5. Electrical characteristics**

Symbol	Parameter	Test conditions	Value			Unit
			Min	Typ	Max	
R <sub>ds(on)</sub>	Static drain source ON state resistance	V <sub>I</sub> = 2.7 V T <sub>J</sub> = 25°C		120	160	mΩ
		V <sub>I</sub> = 5.0 V T <sub>J</sub> = 25°C;		105	115	mΩ
R <sub>ds(on)</sub>	Static drain source ON state resistance	V <sub>I</sub> = 2.7 V -40 < T <sub>J</sub> < 125°C			200	mΩ
		V <sub>I</sub> = 5.0 V -40 < T <sub>J</sub> < 125°C			140	
t <sub>r</sub>	Output rise time (STMPS2242,STMPS2252)	V <sub>I</sub> = 5.0 V R <sub>LOAD</sub> = 10 Ω C <sub>LOAD</sub> = 1 μF	0.05		2	ms
	Output rise time (STMPS2262,STMPS2272)	V <sub>I</sub> = 5.0 V R <sub>LOAD</sub> = 10 Ω C <sub>LOAD</sub> = 1 μF	0.05		2	ms
t <sub>f</sub>	Output fall time (STMPS2242,STMPS2252)	V <sub>I</sub> = 5.0 V R <sub>LOAD</sub> = 10 Ω C <sub>LOAD</sub> = 1 μF	0.05		2	ms
	Output fall time (STMPS2262,STMPS2272)	V <sub>I</sub> = 5.0 V R <sub>LOAD</sub> = 10 Ω C <sub>LOAD</sub> = 1 μF	0.05		2	ms

**Table 6. Current limit characteristics  
(V<sub>I</sub> = 5.5 V, I<sub>O</sub> = rated current, T<sub>J</sub> = 25°C, unless otherwise specified)**

Symbol	Parameter	Test condition	Value			Unit
			Min	Typ	Max	
I <sub>OS</sub> (STMPS2242 STMPS2252)	Short circuit output current	V <sub>I</sub> = 5 V OUT connected to GND through 10 mΩ load, device enabled into short circuit	0.6	0.8	1.0	A
I <sub>OS</sub> (STMPS2262 STMPS2272)			1.1	1.6	2.0	A

**Table 7. Supply current characteristics**  
 ( $V_I = 5.5\text{ V}$ ,  $I_O = \text{rated current}$ ,  $T_J = 25^\circ\text{C}$ , unless otherwise specified)

Symbol	Parameter	Test condition	Value			Unit
			Min	Typ	Max	
$I_{off}$	Switch turned off	No load Switch is off		9	14	$\mu\text{A}$
		No load Switch is off $-40 < T_J < 125^\circ\text{C}$			16	
$I_{on}$	Switch turned on	No load Switch is on		50	70	$\mu\text{A}$
		No load Switch is on $-40 < T_J < 125^\circ\text{C}$			85	
$I_{leakage}$	Output leakage current <sup>(1)</sup>	$I_{off}$ (grounded output) - $I_{off}$ (floating output)		1	2	$\mu\text{A}$
		$I_{off}$ (grounded output) - $I_{off}$ (floating output) $-40 < T_J < 125^\circ\text{C}$		1	6	
$I_{reverse}$	Reversed leakage current	Switch is off $V_I < V_O$ , Output connected to 5.5 V, $25^\circ\text{C}$		1	2	$\mu\text{A}$
		Switch is off $V_I < V_O$ Output connected to 5.5 V, $125^\circ\text{C}$		1	10	

1.  $I_{leakage} = I_{off-ground} - I_{off}$ , where  $I_{off-ground}$  = current into IN when switch is off and output is grounded

**Table 8. Thermal characteristics**  
 ( $V_I = 5.5\text{ V}$ ,  $I_O = \text{rated current}$ ,  $T_J = 25^\circ\text{C}$ , unless otherwise specified)

Symbol	Parameter	Test condition	Value			Unit
			Min	Typ	Max	
T1	Thermal shutdown threshold		135			$^\circ\text{C}$
T2	Recovery from thermal shutdown		125			$^\circ\text{C}$
Hysteresis				10		$^\circ\text{C}$

**Table 9. UVLO characteristics** $(V_I = 5.5 \text{ V}, I_O = \text{rated current}, T_J = 25^\circ\text{C}, \text{ unless otherwise specified})$ 

Symbol	Parameter	Test condition	Value			Unit
			Min	Typ	Max	
$V_{UVLO}$	Undervoltage lockout threshold		2.0		2.5	V
Hysteresis				75		mV

**Table 10. OCx pin characteristics** $(V_I = 5.5 \text{ V}, I_O = \text{rated current}, T_J = 25^\circ\text{C}, \text{ unless otherwise specified})$ 

Symbol	Parameter	Test condition	Value			Unit
			Min	Typ	Max	
OC blanking	OCx assertion and de-assertion		4	8	15	ms
$V_O$	Output low voltage	$I_O = 5 \text{ mA}$	–	–	0.4	V
$I_{off}$	Off current	$V_{OC} = 2.7 \text{ V}, 5.5 \text{ V}$ (No OC condition)	–	–	1.0	$\mu\text{A}$

**Table 11. ENx pin characteristics** $(V_I = 5.5 \text{ V}, I_O = \text{rated current}, T_J = 25^\circ\text{C}, \text{ unless otherwise specified})$ 

Symbol	Parameter	Test condition	Value			Unit
			Min	Typ	Max	
$V_{IH}$	High level input voltage	$V_I = 2.7 \text{ V to } 5.5 \text{ V}$	2.0	–	–	V
$V_{IL}$	Low level input voltage	$V_I = 4.5 \text{ V to } 5.5 \text{ V}$	–	–	0.8	V
		$V_I = 2.7 \text{ V to } 4.5 \text{ V}$	–	–	0.4	V
$I_I$	Input current	$V_{IENx} = 0 \text{ V or } V_I$	-0.5	–	0.5	$\mu\text{A}$
$t_{on}$	Turn ON time <sup>(1)</sup>	$R_{LOAD} = 10 \ \Omega$ $C_{LOAD} = 100 \ \mu\text{F}$	–	–	5	ms
$t_{off}$	Turn OFF time <sup>(1)</sup>	$R_{LOAD} = 10 \ \Omega$ $C_{LOAD} = 100 \ \mu\text{F}$	–	–	10	ms

1. Not tested in production, specified by design.

## 6 Typical operating characteristics

### 6.1 STMP2242, STMP2252 characteristics

The waveforms and characteristics shown in this section pertain to the STMP2252 device. The STMP2242 is expected to have the same characteristics with inverted EN input function. All measurements are at ambient temperature 25 °C.

#### 6.1.1 Turn-on/off characteristics for $V_I = 3\text{ V}$ , $R_{LOAD} = 6\ \Omega$

Figure 3. Turn-on for  $C_{LOAD} = 1\ \mu\text{F}$



Figure 4. Turn-on for  $C_{LOAD} = 100 \mu F$

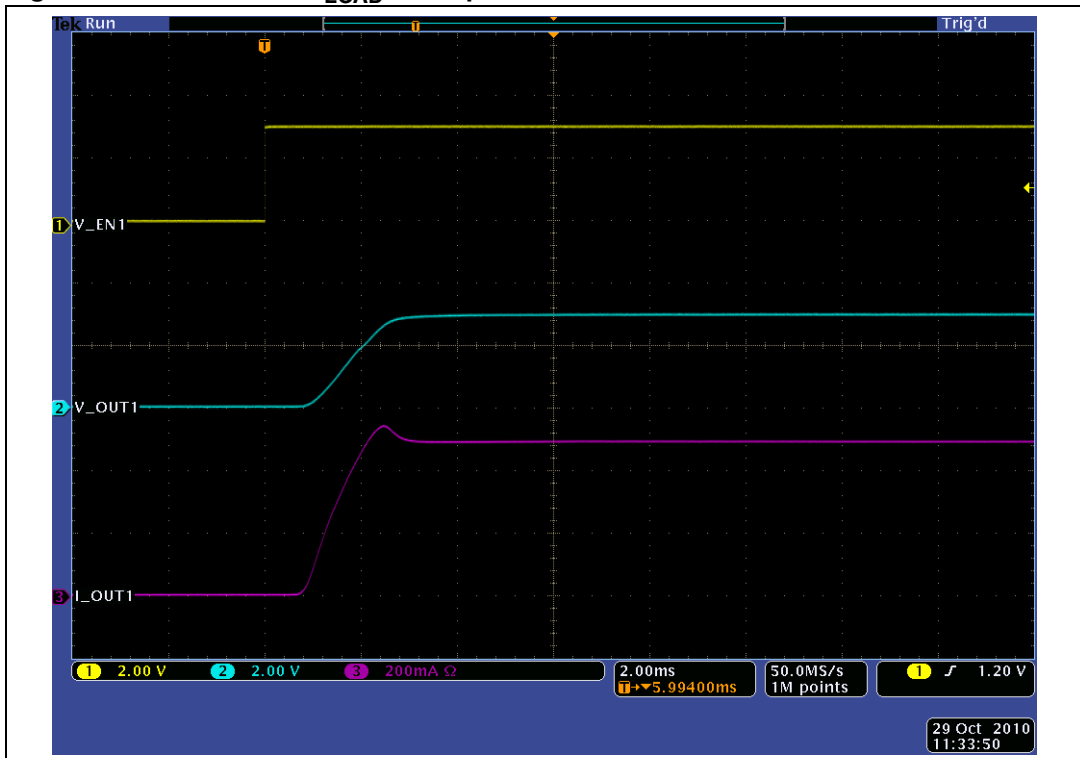


Figure 5. Turn-on for  $C_{LOAD} = 470 \mu F$

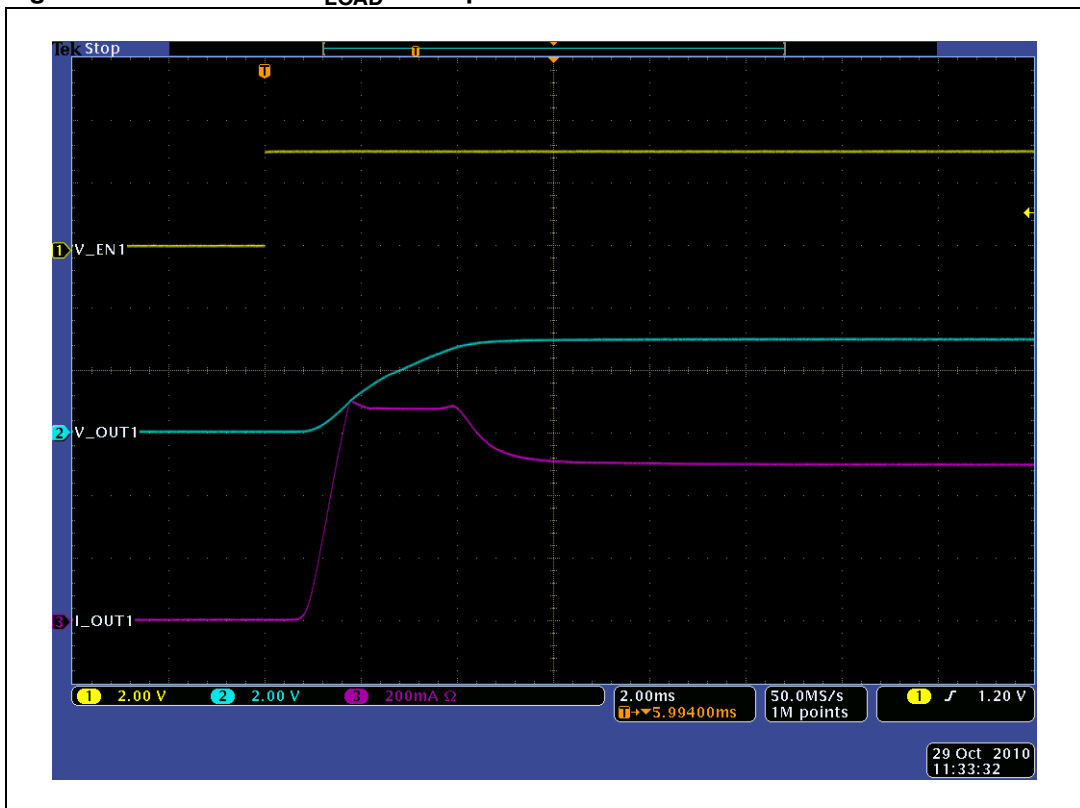


Figure 6. Turn-off for  $C_{LOAD} = 1 \mu F$

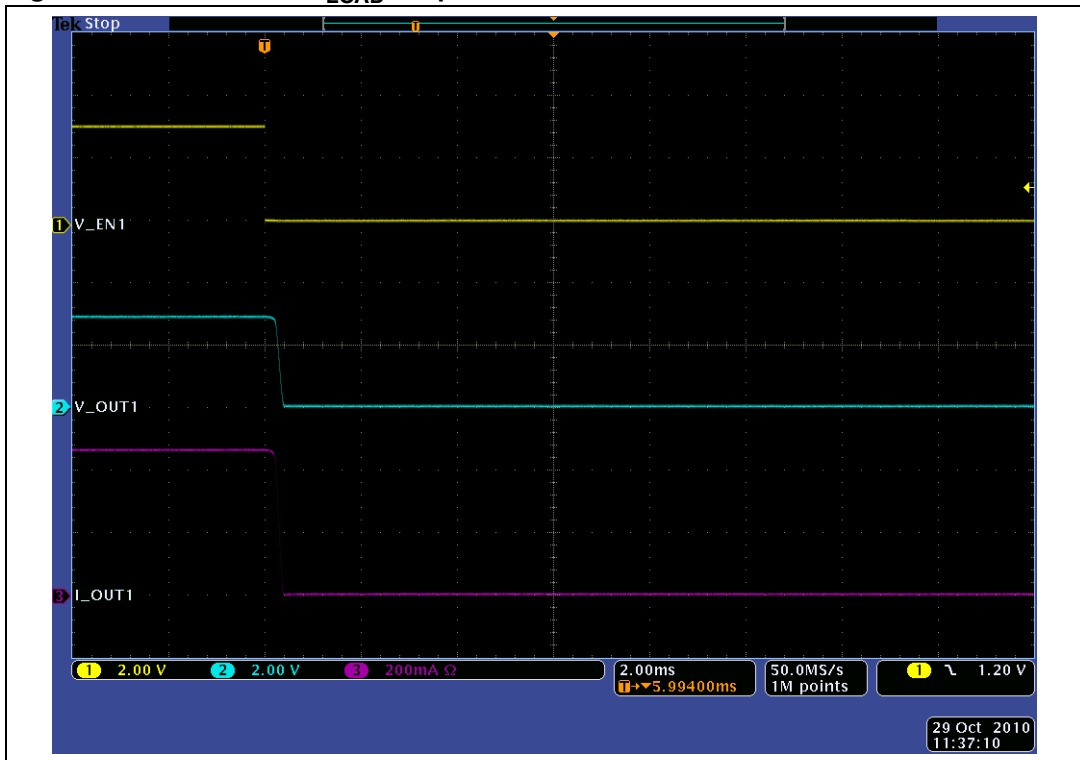


Figure 7. Turn-off for  $C_{LOAD} = 100 \mu F$

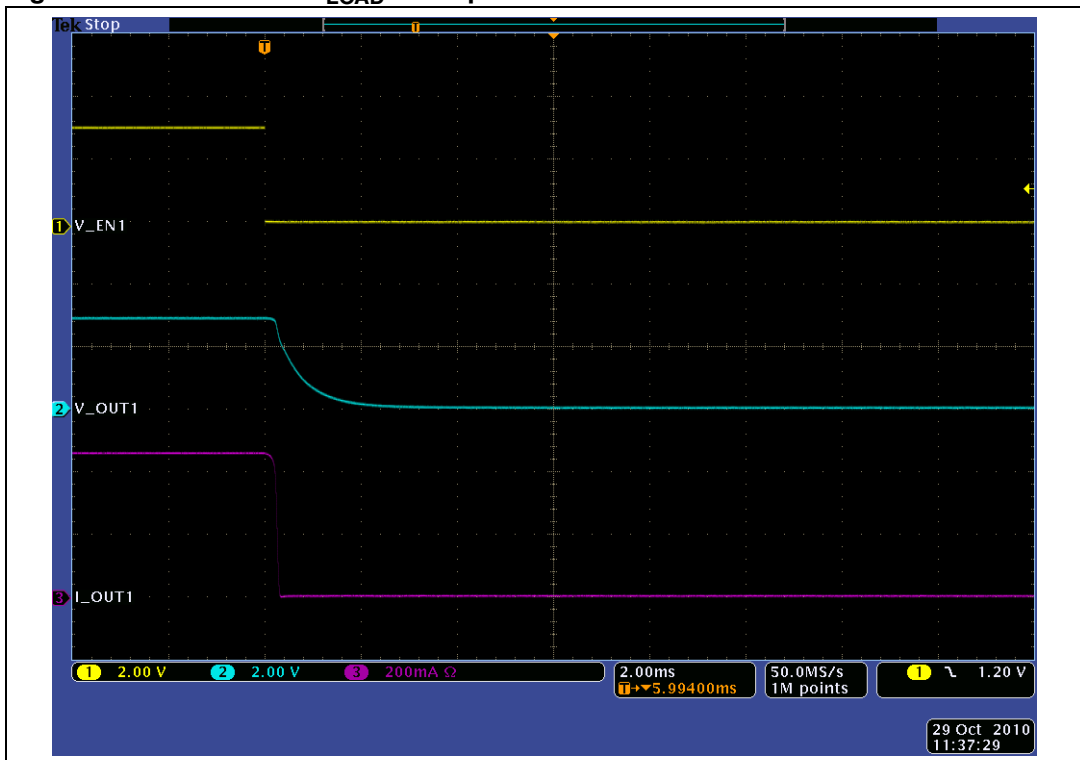
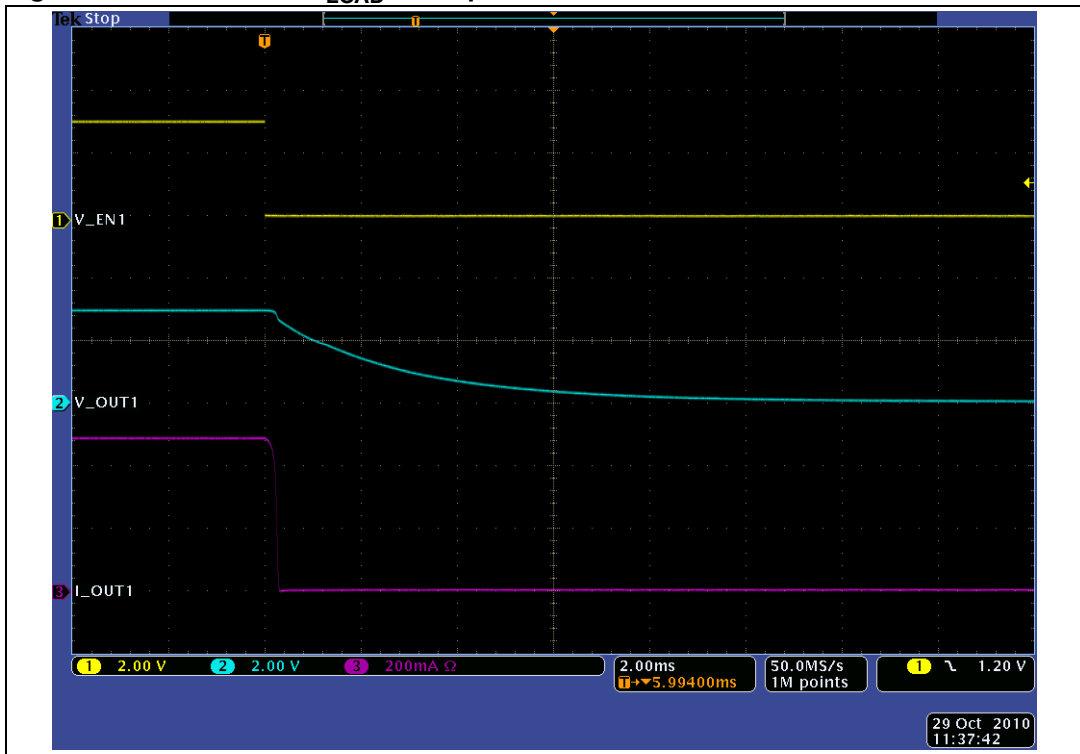




Figure 8. Turn-off for  $C_{LOAD} = 470 \mu F$



### 6.1.2 Turn-on/off characteristics for $V_I = 5 V$ , $R_{LOAD} = 10 \Omega$

Figure 9. Turn-on for  $C_{LOAD} = 1 \mu F$

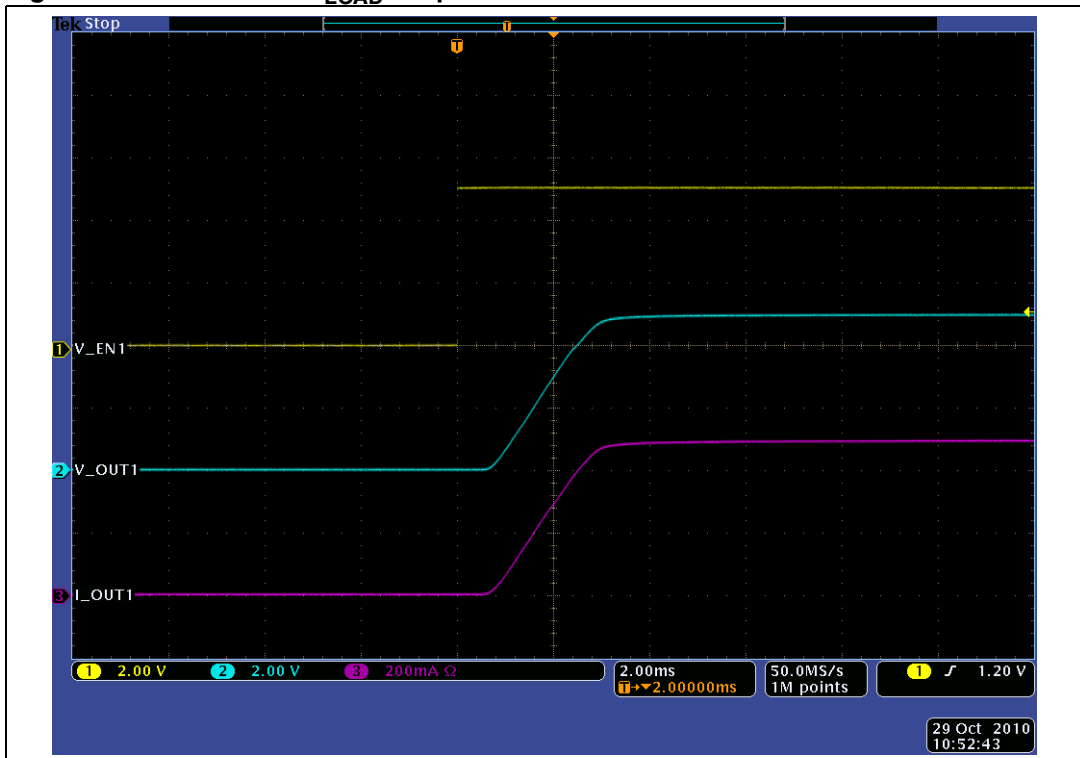


Figure 10. Turn-on for  $C_{LOAD} = 100 \mu F$



Figure 11. Turn-on for  $C_{LOAD} = 470 \mu F$

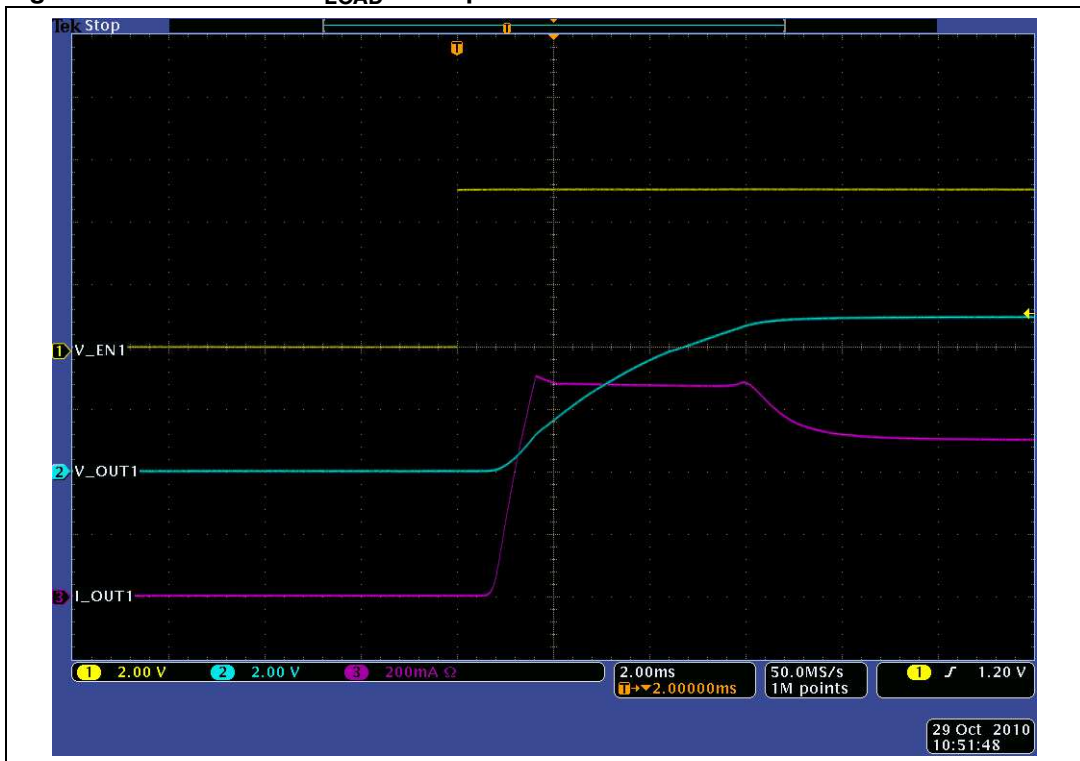


Figure 12. Turn-off for  $C_{LOAD} = 1 \mu F$

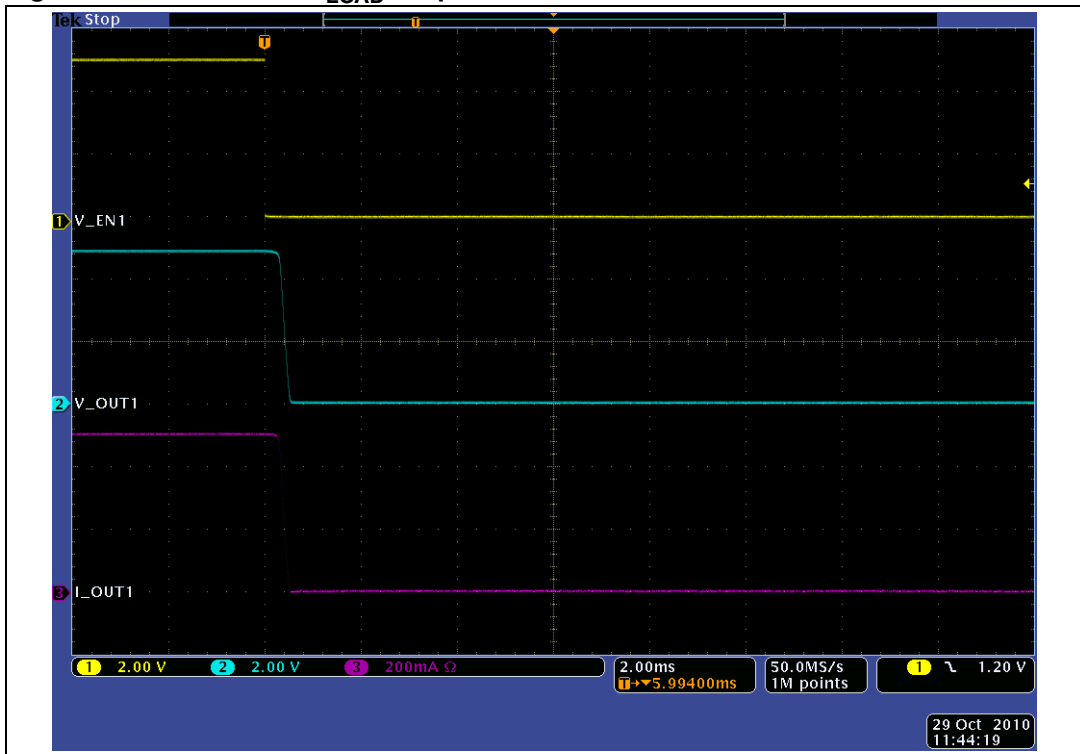


Figure 13. Turn-off for  $C_{LOAD} = 100 \mu F$

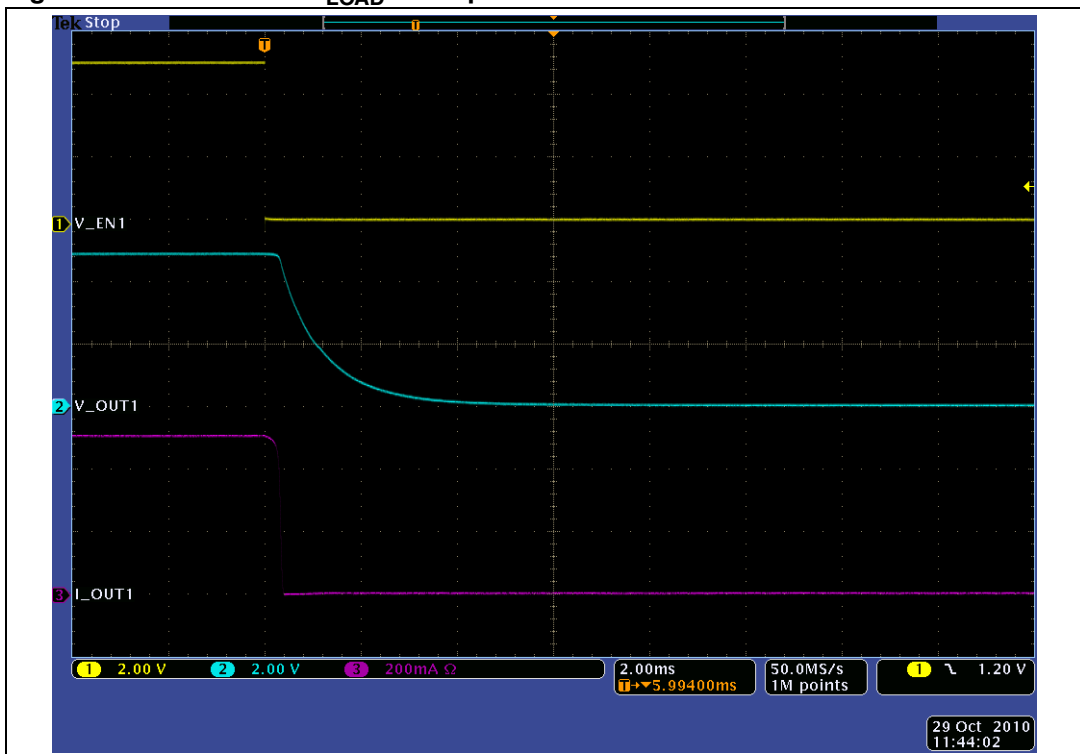
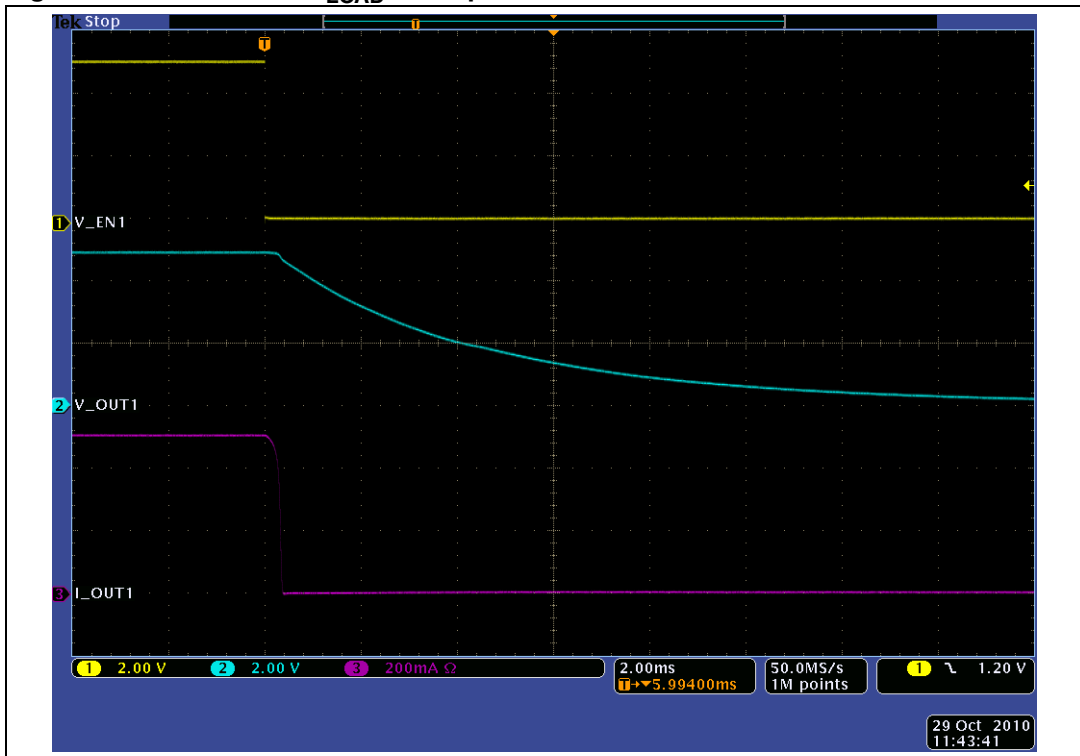


Figure 14. Turn-off for  $C_{LOAD} = 470 \mu F$



### 6.1.3 UVLO characteristics

Figure 15. UVLO,  $V_I$  rising

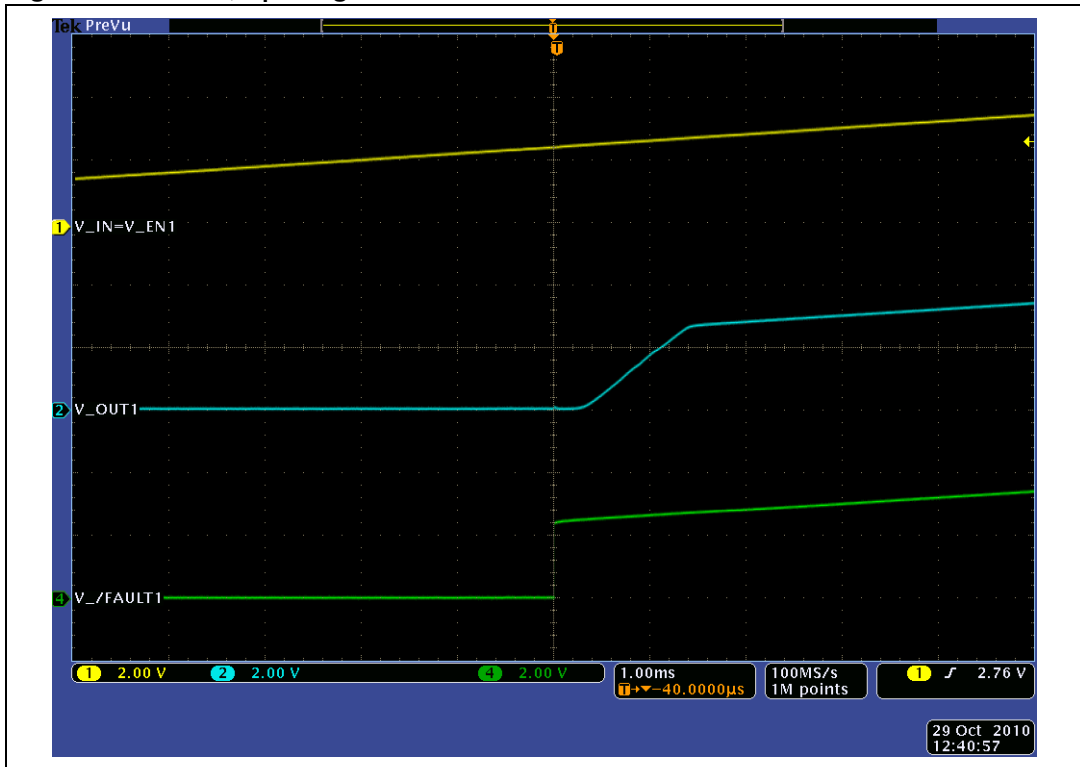
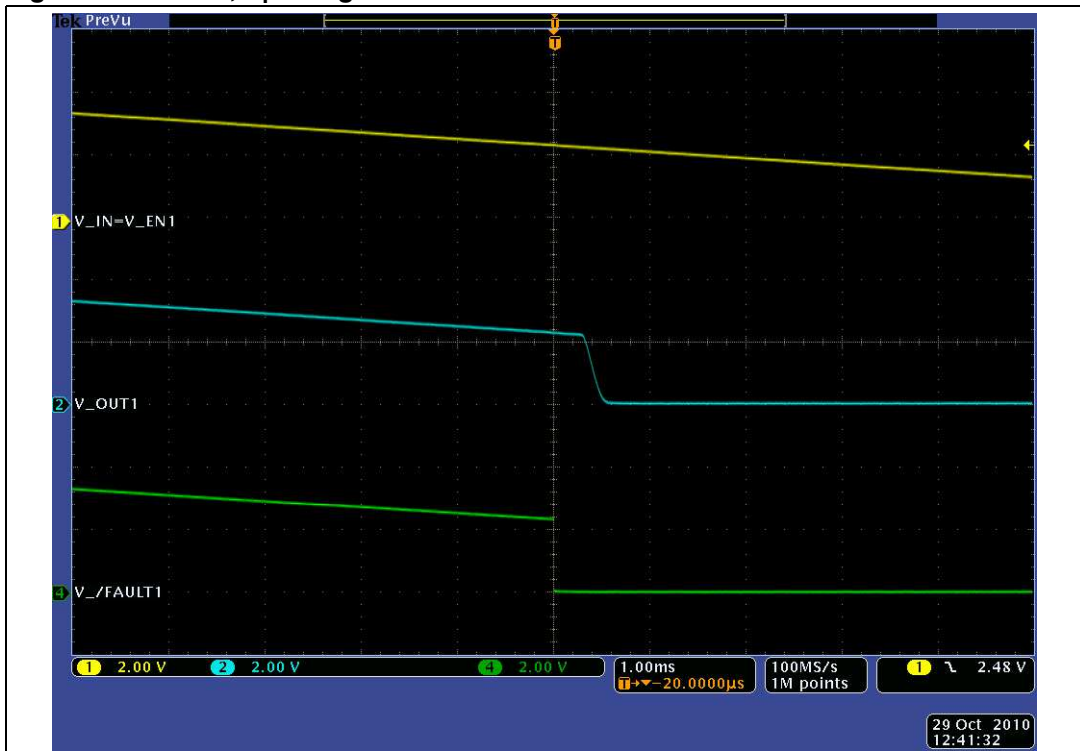


Figure 16. UVLO,  $V_I$  falling



6.1.4 Overcurrent protection characteristics

Figure 17. Overcurrent protection characteristics,  $V_I = 3\text{ V}$ ,  $R_{LOAD} = 2.2\ \Omega$



Figure 18. Overcurrent protection characteristics,  $V_I = 5\text{ V}$ ,  $R_{LOAD} = 2.2\ \Omega$



6.1.5 Other electrical characteristics

Figure 19.  $I_{CC}$  versus  $V_I$

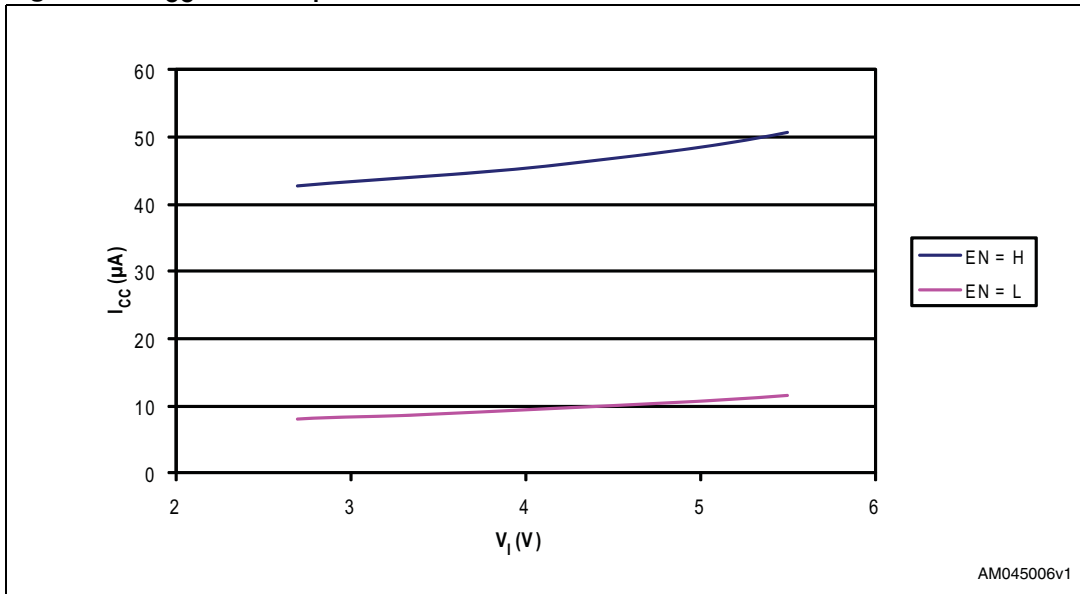


Figure 20.  $t_r$  versus  $V_I$

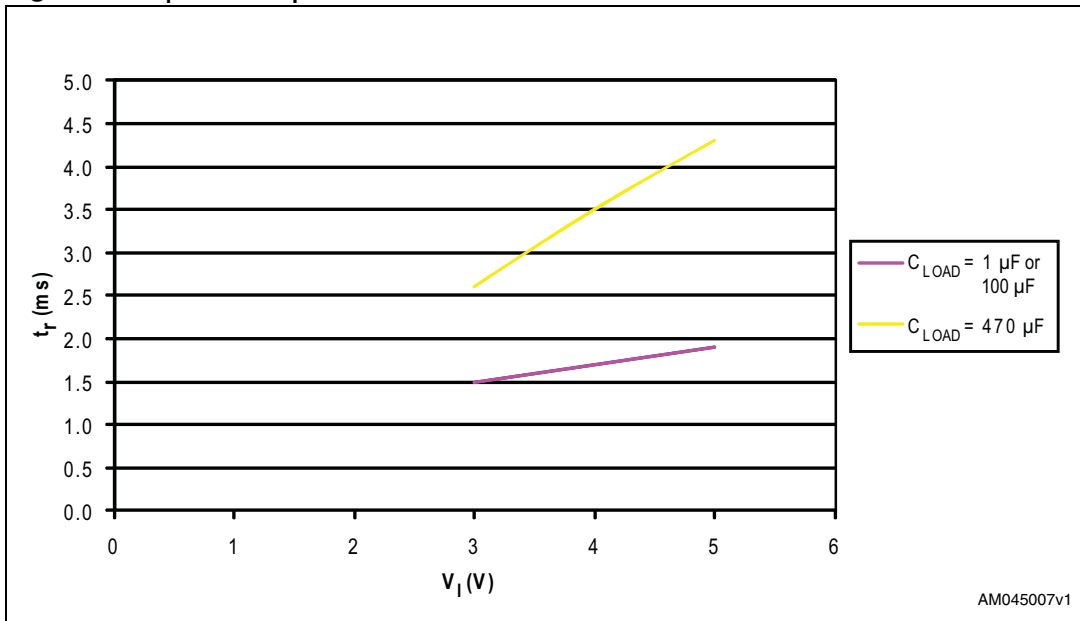


Figure 21.  $t_f$  versus  $V_I$

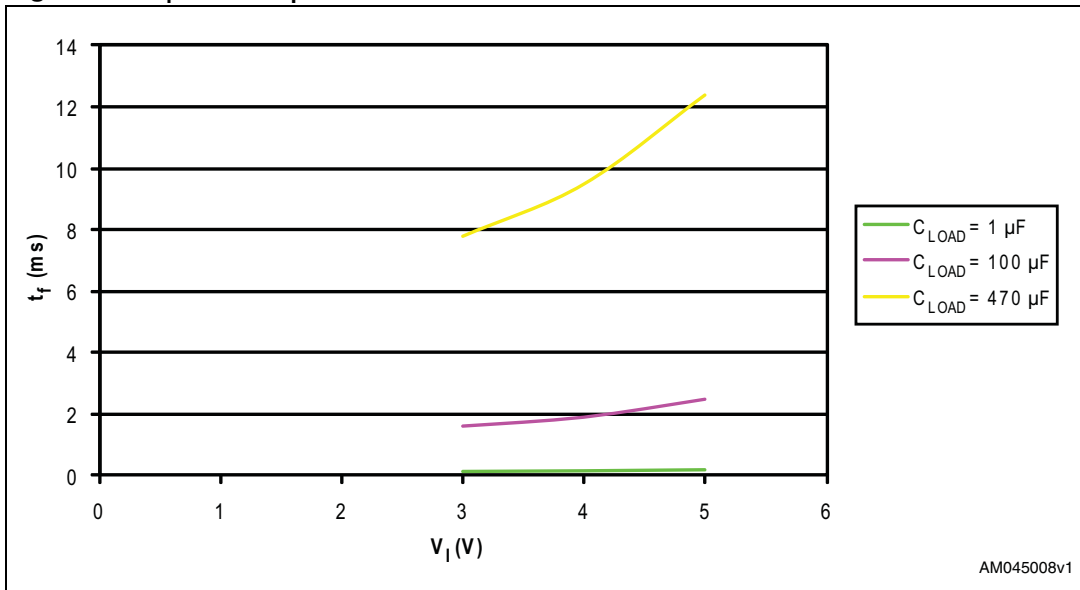
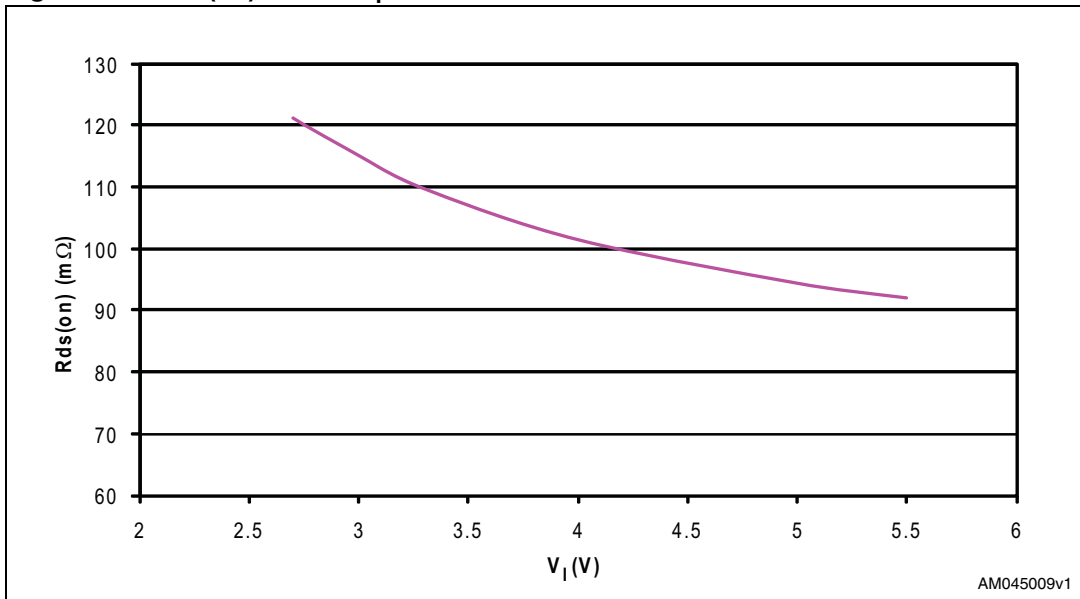


Figure 22.  $R_{ds(on)}$  versus  $V_I$





## 6.2 STMPS2262, STMPS2272 characteristics

The waveforms and characteristics shown in this section pertain to the STMPS2272 device. The STMPS2262 is expected to have the same characteristics with inverted EN input function. All measurements are at ambient temperature 25 °C.

### 6.2.1 Turn-on/off characteristics for $V_I = 3\text{ V}$ , $R_{LOAD} = 3\ \Omega$

Figure 23. Turn-on for  $C_{LOAD} = 1\ \mu\text{F}$



Figure 24. Turn-on for  $C_{LOAD} = 100 \mu F$

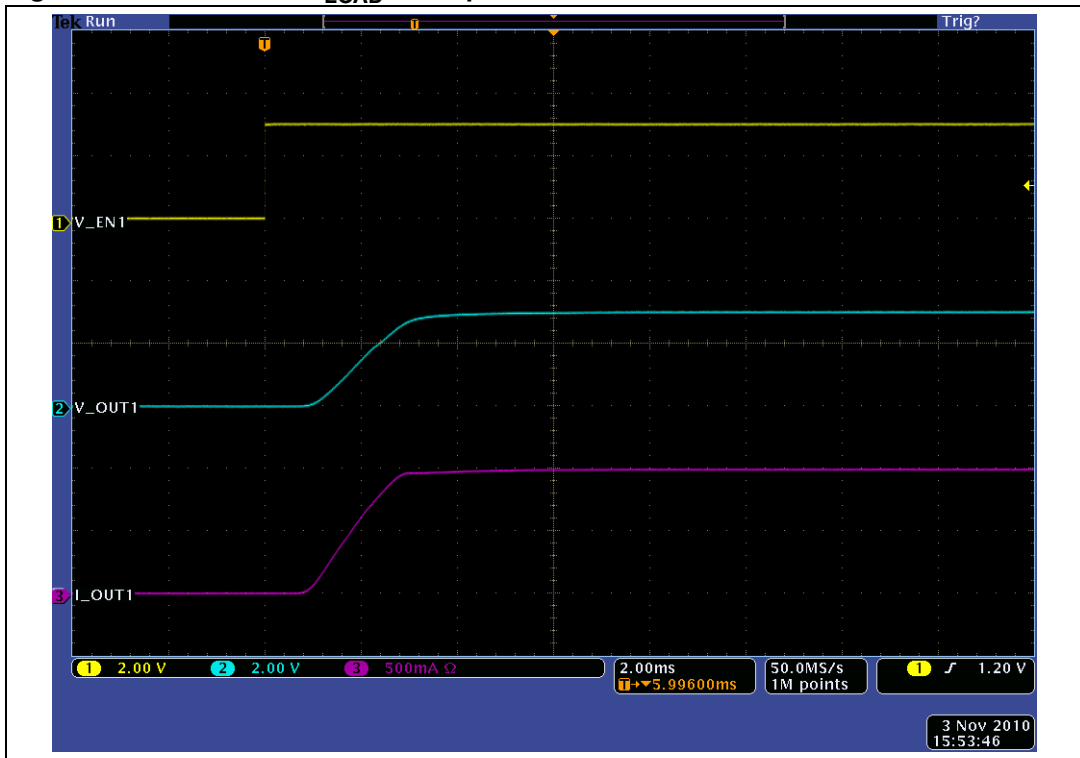


Figure 25. Turn-on for  $C_{LOAD} = 470 \mu F$

